



1. BERYLLIUM COPPER 190 HM 0.125 THICK
2. FINISH: NICKEL UNDERPLATE 1.0/3.0 MICRONS
3. PRE-LOAD FORCE: 0.50 N @ CONTACT POINT
4. FORCE @ MAXIMUM DEFLECTION: 0.73 N @ CONTACT POINT
5. MAXIMUM BEAM DEFLECTION: 0.80mm @ CONTACT POINT
6. CRITICAL DIMENSIONS ARE RINGED.
7. DIMENSIONS MARKED (SPC) ARE SUBJECT TO SPC CONTROL.
8. 3600 PCS ONE REEL WITH 100 LEADER EMPTY POCKETS AND 100 TRAILER EMPTY POCKETS. REEL OUTER DIMETER IS ϕ 330mm, REEL HUB DIMETER IS ϕ 100mm.
9. RECOMMENDED PCB PAD SIZE: 3.36 X 1.10 mm

DO NOT SCALE		PDM:		A3/B	
D RE-2272, CHANG SYMMTRY 0.15 WAS 0.10, ADD WIDTH TOLERANCE C RE-1935, ADD SOLDERING GOLD ZONE B RE-1688, ADD PCB PAD SIZE IN A RE-1438 RELEASED Iss Rev DCN/ECN or Description	01-APR-08 26-FEB-07 10-May-06 27-May-05 Date	Drawn BILLS 01-APR-08 Checked DAVID 01-APR-08 Engineer. BILLS 01-APR-08 Manufact.	Material: BERYLLIUM COPPER 190 HM - 0.125 ± 0.004 THICK	ITT Industries Cannon Electronics (SZ) Co. Ltd. Toupandun Industrial Area, Jinda Cheng, Xiner Village, Shajing Town, Baoan District, Shenzhen City PRC 518125	Pro/E Generic Model Title MICRO UNIVERSAL CONTACT 4.0 mm
		Assembly Quality	Treatment:		Ref:
		Approvals Sign Date	Dimensions in: mm		Cust Spec No:
		This is issued in strict confidence on condition that it is not used as a basis for manufacture or sale and that it is not copied reprinted or disclosed to a third party either wholly or in part without the prior written consent of ITT Industries © 30-Mar-05			Scale 10.000 Sheet 1 of 1
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